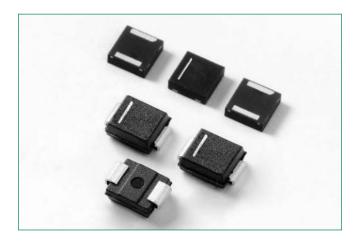
PLED Unidirectional Series

PLED Unidirectional Series (PLEDxUx)

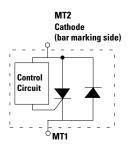




Agency Approvals

| Agency | Agency File Number |
|--------|--------------------|
| 71 | E133083 |

Schematic Symbol



Description

PLED Unidirectional Series (PLEDxUx Series) open LED protectors provide a switching electronic shunt path around a single LED that fails as an open circuit. This ensures the remaining string of LEDs will continue to function even though a single LED in the string has failed open. It also provides reverse battery or reverse power polarity protection.

PLED Unidirectional Series devices were designed to enable higher reliability in outdoor LED lighting applications such as street lighting, outdoor signage, aircraft runway lighting, roadside warning lights and other applications.

Compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic, PLED Unidirectional Series devices are available in two surface mount packages, the DO-214AA and the Quad Flat Pak No-lead (QFN). The QFN's low profile, chip scale package (CSP) is ideal for dense board applications.

Features

- Fast switching
- Reverse Battery/Power Protection
- Automatically resets after power cycle
- Available in low profile, small footprint QFN and Standard DO214AA packages
- Compatible with industrial lighting environments

- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2
- Compatible with PWM frequencies up to 10 kHz
- RoHS compliant and halogen-free
- Recognized to UL 497B as an Isolated Loop Circuit Protector

Electrical Characteristics (All parameters are measured at T_a=25°C unless otherwise noted)

| Part Number | Marking | V Break | BR Cdown | V _{DRM} Breakdown | I _H | I _s | I _T @V _T | V _T | I _F @V _F | V _F | l _o ¹ | Critical rate of rise dV/dt |
|-------------|---------|------------|-------------|-------------------------------|----------------|----------------|--------------------------------|----------------|--------------------------------|----------------|------------------|-----------------------------|
| | | Marking | Vo | lts | Volts | mAmps | mAmps | Amps | Volts | Amps | Volts | Amps |
| | | Min | Max | Min | Max | Max | Max | Max | Max | Max | Min | Max |
| PLED6UQ12 | PL6U | 6 | 16 | 6 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED6US | PL6U | 6 | 16 | 6 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED9UQ12 | PL9U | 9 | 18 | 9 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED9US | PL9U | 9 | 18 | 9 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED13UQ12 | PL13U | 13 | 26 | 13 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | 250V/µs |
| PLED13US | PL13U | 13 | 26 | 13 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED18UQ12 | PL18U | 18 | 33 | 18 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED18US | PL18U | 18 | 33 | 18 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |
| PLED35US | PL35U | 35 | 50 | 35 | 30 | 50 | 1.0 | 1.2 | 1.0 | 1.0 | 1.0 | |

Note:

1. I₀- Operation current tested @ aluminum boards, ambient temp 85°C

PLED Unidirectional Series

Thermal Considerations

| Pacl | kage | Symbol | Parameter | Value | Unit |
|---------|----------|------------------|---|---|------|
| | | T _J | Operating Junction Temperature Range | -40 to +150 | °C |
| QFN 3x3 | DO-214AA | T _s | Storage Temperature Range | -65 to +150 | °C |
| | | R _{ejA} | Thermal Resistance: Junction to Ambient | DO-214AA: 90¹ DO-214AA: 40² QFN: 120¹ QFN: 60³ | °C/W |

Notes:

1) Standard FR-4 PCB with Copper Pads (Recommended Size)

2) Aluminum PCB Thickness: 1.6mm

Grade: 1-2 W/mK Thermal Conductivity Trace thickness: 2 oz

Insulation layer thickness: 215 µm

Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

3) Aluminum PCB

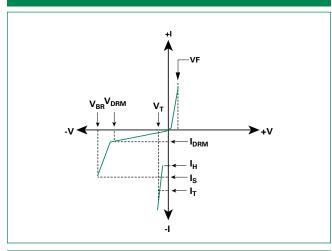
Thickness: 1.6mm Grade: 1-2 W/mK Thermal Conductivity

Trace thickness: 2 oz

Insulation layer thickness: 60 µm

Solder Pad Dimensions: 1.27mm x 2.54mm (Recommended Size)

V-I Characteristics



-6 -8 -40 -20 0 2

Percent of V_{BR} Change

14 12 10

8

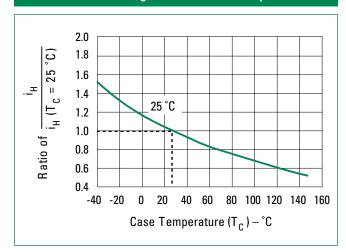
V_{BR} vs. Junction Temperature

25 °C

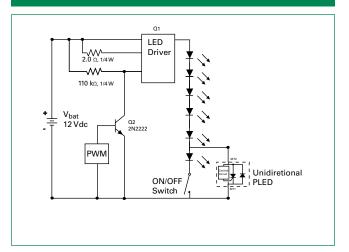
20

Junction Temperature $(T_{J}) - {^{\circ}C}$

Normalized DC Holding Current vs. Case Temperature



LED Interference Test Circuit

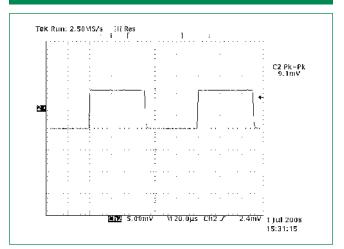


40 60 80 100 120 140 160

PLED Unidirectional Series

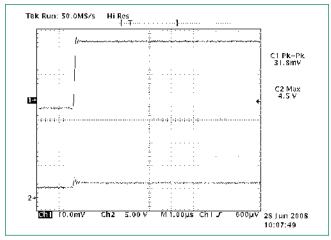
6 LEDs in Series 50% Duty Cycle 10kHz

5 LEDs and 1 PLED in Series 50% Duty Cycle 10kHz



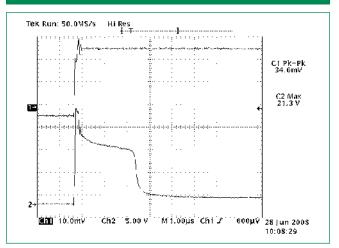
Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA*8.9 = 89mA, while the second figure is 91mA.)

PLED in the Off-State 10kHz



Channel 1: current through LEDs (318 mA) **Channel 2:** voltage across PLED device (4.5 V)

PLED device zeners and then turns fully on 10kHz

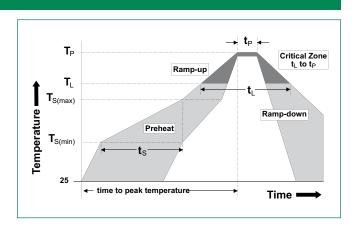


Channel 1: current through LEDs (346 mA) and PLED device once it is fully turned on 2.5 µsec later **Channel 2:** voltage across PLED device (21.3 V before PLED crowbars with 2 V drop)

PLED Unidirectional Series

Soldering Parameters

| Reflow Cond | Pb – Free assembly | | |
|---|--|-------------------------|--|
| Pre Heat | -Temperature Min (T _{s(min)}) | 150°C | |
| | - Temperature Max (T _{s(max)}) | 200°C | |
| | -Time (min to max) (t _s) | 60 – 180 secs | |
| Average ram | np up rate (Liquidus Temp (T _L) to peak | 3°C/second max | |
| $T_{\text{S(max)}}$ to T_{L} - | T _{S(max)} to T _L - Ramp-up Rate | | |
| Reflow | -Temperature (T _L) (Liquidus) | 217°C | |
| nellow | -Temperature (t _L) | 60 - 150 seconds | |
| Peak Temperature (T _p) | | 260 ^{+0/-5} °C | |
| Time within | 5°C of actual peak Temperature (t_p) | 30 seconds | |
| Ramp-down | 6°C/second max | | |
| Time 25°C to | 8 minutes max | | |
| Do not exce | ed | 260°C | |



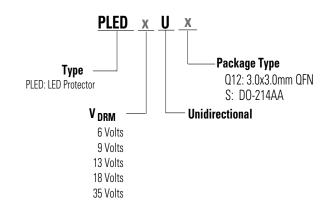
Physical Specifications

| Terminal Material | Copper Alloy |
|-------------------|---|
| Terminal Finish | 100% Matte Tin Plated |
| Body Material | UL recognized compound meeting flammability |

Environmental Specifications

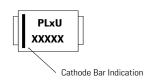
| High Temperature Voltage Blocking | MIL-STD-750: Method 1040, Condition A 80% min V _{DRM} (VAC-peak), 150°C, 504 hours |
|--------------------------------------|---|
| Temperature Cycling | MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles |
| Biased Temperature & Humidity | EIA/JEDEC: JESD22-A101 52VDC, 85°C, 85%RH, 1008 hours |
| High Temperature Storage | MIL-STD-750: Method 1031 150°C, 1008 hours |
| Low Temperature Storage | -65°C, 1008 hours |
| Thermal Shock | MILSTD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles |
| Resistance to Solder Heat | MIL-STD-750: Method 2031 260°C, 10 seconds |
| Moisture Sensitivity Level | 85%RH, +85°C, 168 hrs, 3 Reflow Cycles (+260°C Peak). JEDEC-JSTD-020, Level 1 |

Part Numbering System

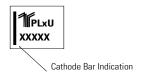


Part Marking System

DO-214AA





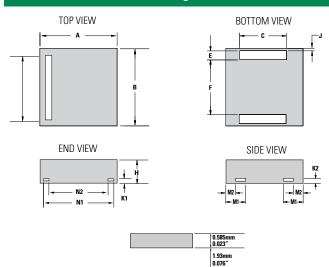


PLED Unidirectional Series

Packaging

| Package | Description | Packaging Quantity | Industry Standard |
|---------|-------------|--------------------|-------------------|
| Q12 | QFN 3x3 | 5000 | EIA-481-1 |
| S | DO-214AA | 2500 | EIA-481-1 |

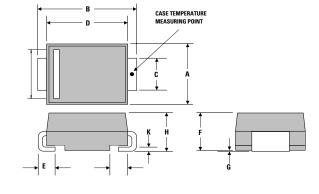
Dimensions - QFN (3x3) Package



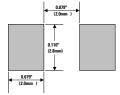
| Dimensions | | Inches | | I | /lillimeter: | S |
|------------|-------|--------|------------------|---------------|--------------|-------|
| Dimensions | Min | Тур | Max | Min | Тур | Max |
| Α | 0.114 | 0.118 | 0.122 | 2.900 | 3.000 | 3.100 |
| В | 0.114 | 0.118 | 0.122 | 2.900 | 3.000 | 3.100 |
| С | 0.075 | 0.079 | 0.083 | 1.900 | 2.000 | 2.100 |
| E | 0.011 | 0.015 | 0.019 | 0.285 | 0.385 | 0.485 |
| F | 0.076 | 0.080 | 0.084 | 1.930 | 2.030 | 2.130 |
| Н | 0.035 | 0.039 | 0.043 | 0.900 | 1.000 | 1.100 |
| J | 0.000 | 0.004 | 0.008 | 0.000 | 0.100 | 0.200 |
| K1 | 0.004 | 0.008 | 0.012 | 0.100 | 0.200 | 0.300 |
| K2 | 0.004 | 0.008 | 0.012 0.100 0.20 | | 0.200 | 0.300 |
| M1 | 0.056 | 0.060 | 0.064 | 1.143 | 1.530 | 1.630 |
| M2 | 0.038 | 0.042 | 0.046 | 0.970 | 1.070 | 1.170 |
| N1 | 0.096 | 0.100 | 0.104 | 2.440 | 2.540 | 2.640 |
| N2 | 0.082 | 0.086 | 0.090 | 0 2.080 2.180 | | 2.280 |
| | | | | | | |

Recommended solder pad layout (Reference Only)

Dimensions - DO-214 AA Package



| Dimensions | Inc | hes | Millimeters | | |
|--------------|-------|-------|-------------|------|--|
| Difficusions | Min | Max | Min | Max | |
| Α | 0.130 | 0.156 | 3.30 | 3.95 | |
| В | 0.201 | 0.220 | 5.10 | 5.60 | |
| С | 0.077 | 0.087 | 1.95 | 2.20 | |
| D | 0.159 | 0.181 | 4.05 | 4.60 | |
| E | 0.030 | 0.063 | 0.75 | 1.60 | |
| F | 0.075 | 0.096 | 1.90 | 2.45 | |
| G | 0.002 | 0.008 | 0.05 | 0.20 | |
| Н | 0.077 | 0.104 | 1.95 | 2.65 | |
| К | 0.006 | 0.016 | 0.15 | 0.41 | |

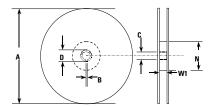


Recommended solder pad layout (Reference Only)

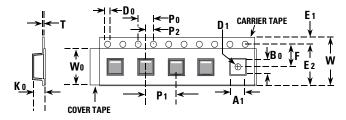


PLED Unidirectional Series

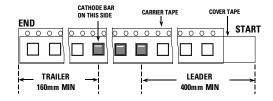
Tape and Reel Specification - QFN (3x3)



Reel Dimension



Tape Dimension Items

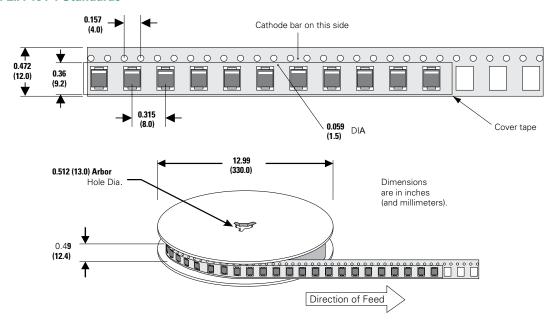


Leader and Trailer Dimension of the Ttape

Inches Millimeters Symbols Description Min Max Min Max Reel Diameter N/A 12.992 N/A 330.0 В Drive Spoke Width 0.059 N/A 1.50 N/A С Arbor Hole Diameter 0.504 0.531 12.80 13.50 D Drive Spoke Diameter 0.795 N/A 20.20 N/A Ν **Hub Diameter** 1.969 N/A 50.00 N/A W1 Reel Inner Width at Hub 0.488 0.567 12.40 14 40 Pocket Width at bottom A0 0.126 0.134 3.20 3.40 Pocket Length at bottom B0 0.126 0 134 3 20 3 40 1.60 D0 Feed Hole Diameter 0.059 0.063 1.50 D1 Pocket Hole Diameter 0.059 N/A 1.50 N/A **E1** Feed hole Position 1 0.065 0.073 1.65 1.85 **E2** Feed hole Position 2 0.400 0.408 10.15 10.35 F 0.215 0.219 Feed hole center-Pocket hole 5.45 5.55 K0 Pocket Depth 0.051 0.039 1.00 1.30 P0 Feed hole Pitch 0.153 0.161 3.90 4.10 Р1 0.311 0.319 7.90 8.10 Component Spacing P2 0.081 Feed hole center-Pocket hole 0.077 2.06 1.90 0.35 т Carrier Tape Thickness 0.010 0.014 0.25 w Embossed Carrier Tape Width 0.453 0.484 11.50 12.30 WO Cover Tape Width 0.358 0.366 9.10 9.30

DO-214AA Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards



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